

Mounting Option

.128 (3.25) Dia. Mounting Holes

Contact Detail

90 Degree Bend (Code 527 Contacts)

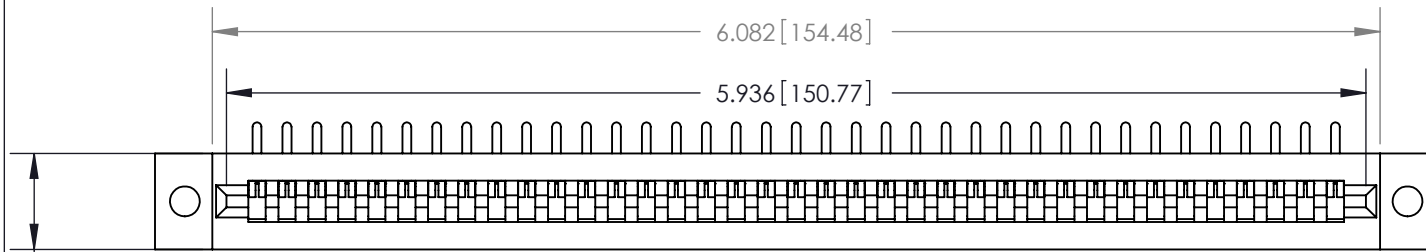
.156 [3.96] Contact Spacing x .200 [5.08] Row Spacing

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ISSUE NUMBER

ORIGINAL



0.500 [12.70]

0.473 [12.01]

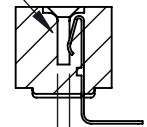
A

A

EDAC

.095 [2.41] Point of Contact
(Measured from bottom of Card Slot)

SECTION A-A



Card Slot Accepts .054 [1.37]
to .070 [1.78] Thick P.C. Board

See Accompanying Page for:

- Contact Bend Details

807/857 Series High Temp Card Edge Connector

Part Number: 857-037-559-102



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DRAWN: J.LEE DATE: AUG. 11/09

CHECKED: DATE:

SCALE: NTS SHEET 1 OF 2

DRAWING NUMBER 807 Assembly ISSUE 1

Single Row Contacts - Read One Side of Daughter Board

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ISSUE NUMBER

ORIGINAL



558 Contact Code



559 Contact Code

Single Row Contacts - Read Both Sides of Daughter Board



553 Contact Code



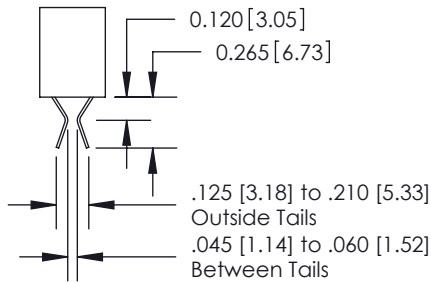
554 Contact Code



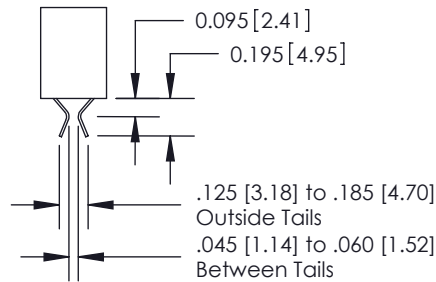
557 Contact Code

Dual Row Contacts - Read Both Sides of Daughter Board

0.240 [6.10] Up to 27/54 Pin
0.162 [4.11] 28/56 and Over



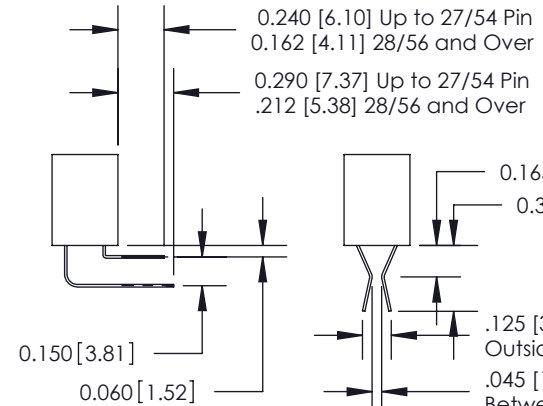
555 Contact Code



556 Contact Code



558 Contact Code



559 Contact Code



560 Contact Code

807 Series High Temp Card Edge Connector Contact Bend Detail



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SCALE: NTS SHEET 2 OF 2

DRAWING NUMBER ISSUE

807 Assembly

1